# 山东晶导微电子股份有限公司 Jingdao Microelectronics co.LTD MBR1040xT THRU MBR10200xT

## SCHOTTKY BARRIER RECTIFIERS

Reverse Voltage - 40 to 200 V

Forward Current - 10 A

### FEATURES

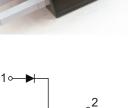
- High current capability
- Low forward voltage drop
- · Low power loss, high efficiency
- High surge capability
- High temperature soldering guaranteed
- Mounting position: any



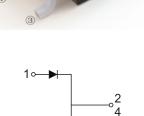
TO-252(D-PAK)



30



Λ



### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified

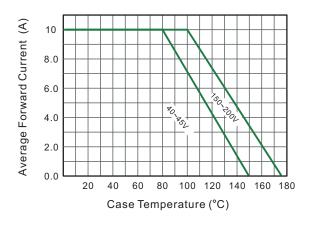
CHARACTERISTICS	TO-251	MBR1040VT	MBR1045VT	MBR1060VT	MBR10100VT	MBR10150VT	MBR10200VT	Units				
CHARACTERISTICS	TO-252	MBR1040DT	MBR1045DT	MBR1060DT	MBR10100DT	MBR10150DT	MBR10200DT	Units				
Maximum Recurrent Peak Reverse Voltage	$V_{\text{RRM}}$	40	45	60	100	150	200	V				
Maximum RMS voltage	$V_{\text{RMS}}$	28	31.5	42	70	105	140	V				
Maximum DC Blocking Voltage	$V_{\text{DC}}$	40	45	60	100	150	200	V				
Maximum Average Forward Rectified Current	I <sub>F(AV)</sub>		10									
Peak Forward Surge Current,8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I <sub>FSM</sub> 100											
Max Instantaneous Forward Voltage at 5 A DC per leg	V <sub>F</sub>	0.	70	0.75	0.85 0.90		0.92	V				
Maximum DC Reverse Current $T_a = 25^{\circ}C$ at Rated DC Reverse Voltage $T_a = 125^{\circ}C$	I <sub>R</sub>		0.1 20	0.05 20								
Typical Junction Capacitance <sup>(1)</sup>	Cj	600 400										
Typical Thermal Resistance <sup>(2)</sup>	$R_{\theta JA}$		45									
Operating Junction Temperature Range	g Junction Temperature Range T <sub>j</sub> -55 ~ +150 -55 ~ +175											
Storage Temperature Range	T <sub>stg</sub>		-55 ~	+150		-55 ~	°C					

( 1 ) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(2) P.C.B. mounted with 10cmX10cmX1mm copper pad areas.

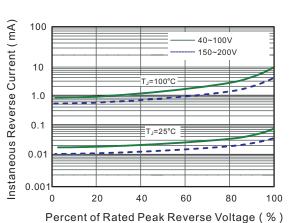
山东晶导微电子股份有限公司 Jingdao Microelectronics co.LTD MBR1040xT THRU MBR10200xT

#### Fig.1 TYPICAL FORWARD CURRENT DERATING CURVE



TJ=25°C

20



#### Fig.2 Typical Reverse Characteristics

Fig.4 Typical Junction Capacitance

T = 25°C

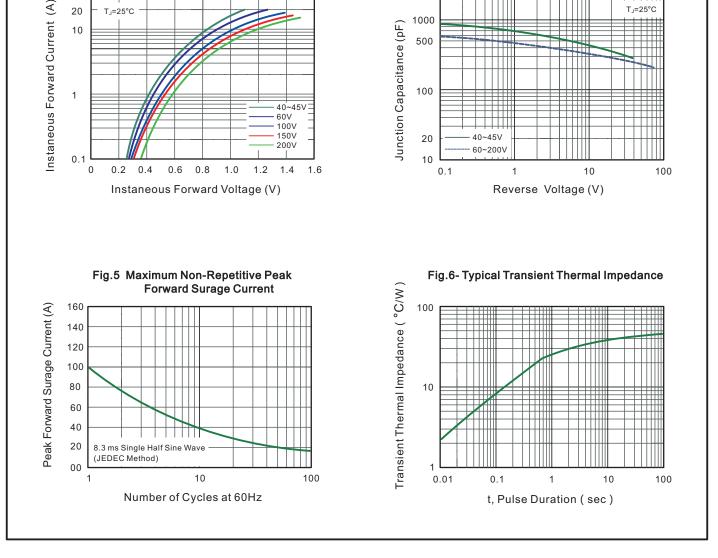
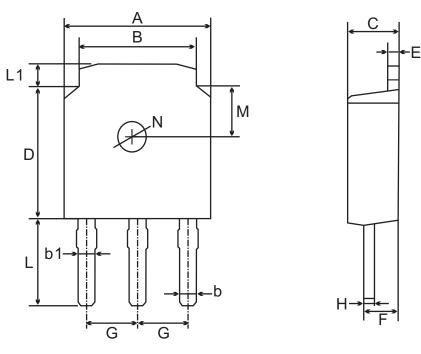


Fig.3 Typical Forward Characteristic

## TO-251(D-PAK) Package Outline Dimensions



### TO-251(I-PAK) mechanical data

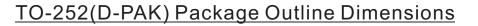
	UN	IIT	A	В	b	b1	С	D	Е	F	G	н	L	L1	М	N	
	mm –	max	6.7	5.5	0.8	0.9	2.5	6.3	0.6	1.8	2.29	0.55 4.3		1.2	1.8	1.3	
		min	6.3	5.1	0.3	0.76	2.1	5.9	0.4	1.3	TYPICAL	0.45	3.9	0.8	TYPICAL	TYPICAL	
	mil	max	264	64 217 31 35 98 248 24 71 <sub>90</sub>	90	22	169	47	71	51							
	mii	min	248	201	12	30	83	232	16	51	TYPICAL	18	154	31	TYPICAL	TYPICAL	

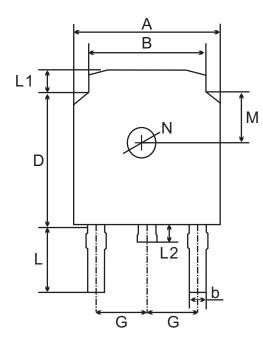
# Important Notice and Disclaimer

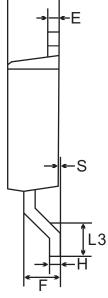
Jingdao Microelectronics reserves the right to make changes to this document and its products and specifications at any time without notice. Customers should obtain and confirm the latest product information and specifications before final design, purchase or use.

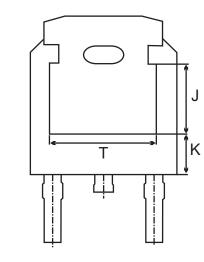
Jingdao Microelectronics makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, not does Jingdao Microelectronics assume any liability for application assistance or customer product design. Jingdao Microelectronics does not warrant or accept any liability with products which are purchased or used for any unintended or unauthorized application.

No license is granted by implication or otherwise under any intellectual property rights of Jingdao Microelectronics. Jingdao Microelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of Jingdao Microelectronics.









TO-252(D-PAK) mechanical data

U	Π	А	В	b	С	D	Е	F	G	Н	L	L1	L2	L3	S	М	Ν	J	К	Т
mm	max	6.7	5.5	0.8	2.5	6.3	0.6	1.8	2.29 TYPICAL	0.55	3.1	1.2	1.0	1.75	0.1	1.8 TYPICAL	-	3.16 ref.		4.83 ref.
	min	6.3	5.1	0.3	2.1	5.9	0.4	1.3		0.45	2.7	0.8	0.6	1.40	0.0					
I	max	264	217	31	98	248	24	71	90	22	122	47	39	69	4	71	51	124	71	190
mil	min	248	201	12	83	232	16	51	TYPICAL	18	106	31	24	55	0	TYPICAL	TYPICAL	ref.	ref.	ref.

Jingdao Microelectronics reserves the right to make changes to this document and its products and specifications at any time without notice. Customers should obtain and confirm the latest product information and specifications before final design, purchase or use.

Jingdao Microelectronics makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, not does Jingdao Microelectronics assume any liability for application assistance or customer product design. Jingdao Microelectronics does not warrant or accept any liability with products which are purchased or used for any unintended or unauthorized application.

No license is granted by implication or otherwise under any intellectual property rights of Jingdao Microelectronics. Jingdao Microelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of Jingdao Microelectronics.